DATA SHEET



MOS FIELD EFFECT TRANSISTOR

2SK2462

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2462 is N-Channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

Low On-Resistance

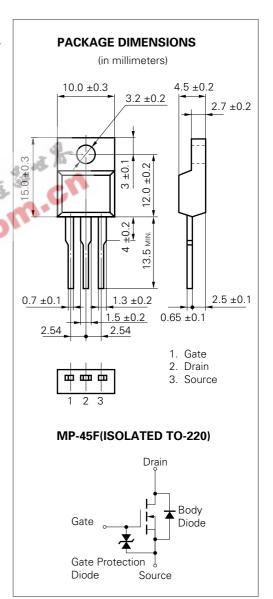
RDS(on)1 = 0.14 Ω MAX. (@ VGS = 10 V, ID = 8.0 A) RDS(on)2 = 0.17 Ω MAX. (@ VGS = 4 V, ID = 8.0 A)

- Low Ciss Ciss = 790 pF TYP.
- Built-in G-S Gate Protection Diodes
- · High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	100	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID(DC)	±15	Α
Drain Current (pulse)*	D(pulse)	±60	Α
Total Power Dissipation (T _c = 25 °C)	P _{T1}	30	W
Total Power Dissipation (TA = 25 °C)	P _{T2}	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	T_{stg}	-55 to +150	°C
Single Avalanche Current**	las	15	Α
Single Avalanche Energy**	Eas	22.5	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0



The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding rated voltage may be applied to this device.

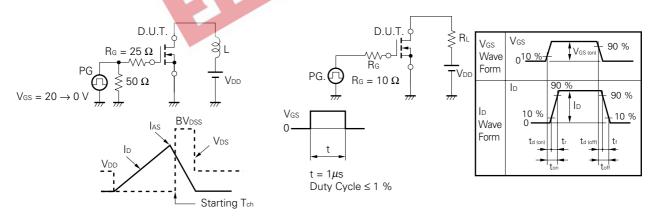


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

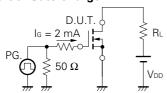
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CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS(on)1		0.10	0.14	Ω	Vgs = 10 V, ID = 8.0 A
Drain to Source On-Resistance	R _{DS(on)2}		0.12	0.17	Ω	Vgs = 4 V, ID = 8.0 A
Gate to Source Cutoff Voltage	V _{GS(off)}	1.0	1.6	2.0	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	l yfs l	7.0	14		S	V _{DS} = 10 V, I _D = 8.0 A
Drain Leakage Current	IDSS			10	μΑ	V _{DS} = 100 V, V _{GS} = 0
Gate to Source Leakage Current	Igss			±10	μΑ	$V_{GS} = \pm 20 \text{ V, } V_{DS} = 0$
Input Capacitance	Ciss		790		pF	V _{DS} = 10 V
Output Capacitance	Coss		280		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		88		pF	f = 1 MHz
Turn-On Delay Time	td(on)		16		ns	ID = 8.0 A
Rise Time	tr		110		ns	VGS(on) = 10 V
Turn-Off Delay Time	td(off)		88		ns	V _{DD} = 50 V
Fall Time	tf		62		ns	$R_G = 10 \Omega$
Total Gate Charge	Q _G		33	-	nC	ID = 15 A
Gate to Source Charge	Qgs		5.4	人為	nC	VDD = 80 V
Gate to Drain Charge	Q _{GD}		25		nC	Vgs = 10 V
Body Diode Forward Voltage	V _{F(S-D)}		1,1	60	V	IF = 15 A, VGS = 0
Reverse Recovery Time	trr	1 1	160	1	ns	IF = 15 A, VGS = 0
Reverse Recovery Charge	Qrr),	670		nC	di/dt = 100 A/μs

Test Circuit 1 Avalanche Capability

Test Circuit 2 Switching Time

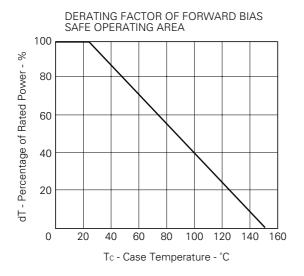


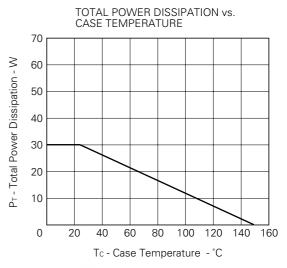
Test Circuit 3 Gate Charge

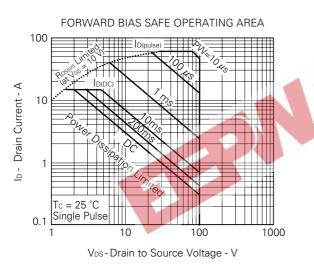


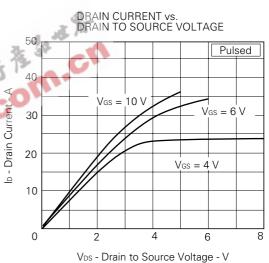
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

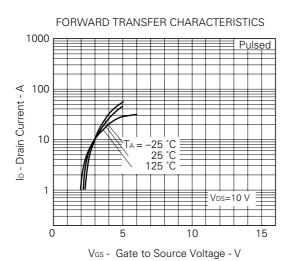
TYPICAL CHARACTERISTICS (TA = 25 °C)



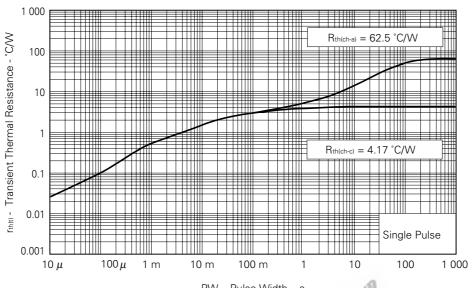




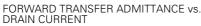


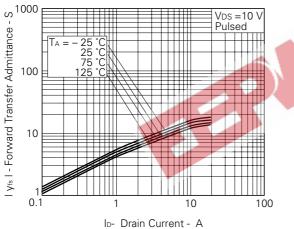


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

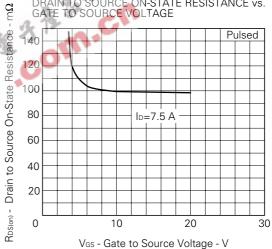


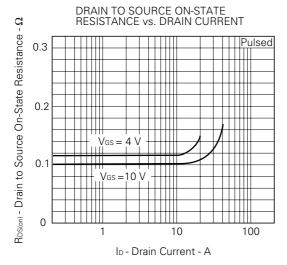
PW - Pulse Width - s



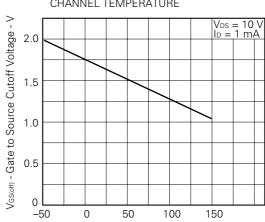


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

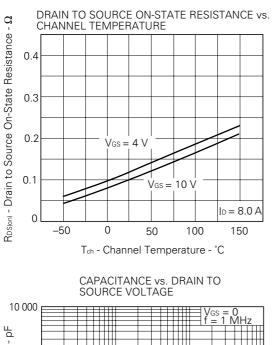


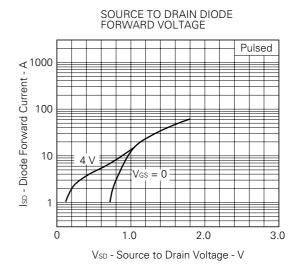


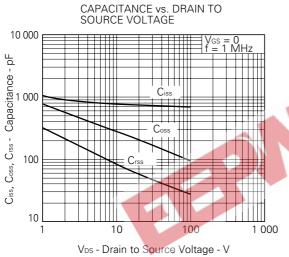
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

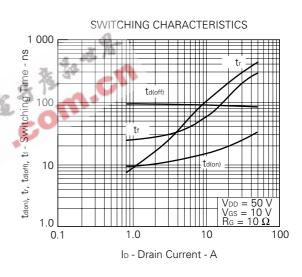


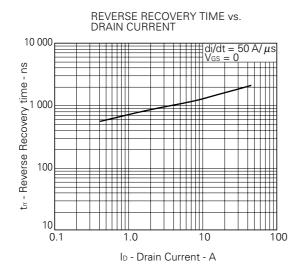
Tch - Channel Temperature - °C

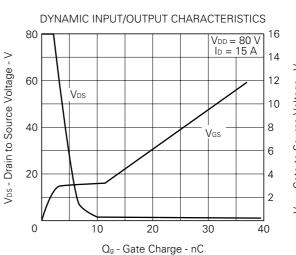


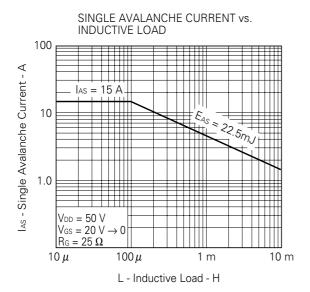


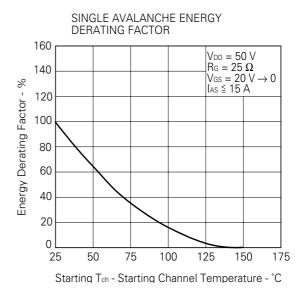
















REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037



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NEC 2SK2462

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Anti-radioactive design is not implemented in this product.